

Global IC Package Substrate Market Research Report 2017

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Abstracts

Notes:

Production, means the output of IC Package Substrate

Revenue, means the sales value of IC Package Substrate

This report studies IC Package Substrate in Global market, especially in North America, Europe, China, Japan, Southeast Asia and India, focuses on top manufacturers in global market, with capacity, production, price, revenue and market share for each manufacturer, covering

Honeywell ACI

IBM

Unimicron

Multek

AT&S

Aspocomp

JCI(MGC)

Hitachi?Cable

Ibiden

Samsung

Shinko

Market Segment by Regions, this report splits Global into several key Regions, with production, consumption, revenue, market share and growth rate of IC Package Substrate in these regions, from 2011 to 2021 (forecast), like

North America

Europe

China

Japan

Southeast Asia

India

Split by product type, with production, revenue, price, market share and growth rate of each type, can be divided into

Ball Grid Array(BGA)

Chip Scale Package/Chip Size Package(CSP)

Flip Chip(FC)

Split by application, this report focuses on consumption, market share and growth rate of IC Package Substrate in each application, can be divided into

Mobile Telephone

PC

Camera

Others

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